

**Surface Mount Glass Passivated Junction Rectifiers
Reverse Voltage 50 to 1000V Forward Current 1.0A**

FEATURES

- * Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- * High temperature metallurgically bonded construction
- * Cavity-free glass passivated junction
- * Capable of meeting environmental standards of MIL-S-19500
- * 1.0 A operation at TA=75°C with no thermal runaway
- * Typical IR less than 1.0µA
- * High temperature soldering guaranteed: 260°C/10 seconds

Mechanical Data

Case: JEDEC SOD123-FL/MINI SMA, molded plastic over glass DIE

Terminals: Tin Plated, solderable per
MIL-STD-750, Method 2026

Polarity: Color band denotes cathode end

Mounting Position: Any

Weight: 0.0155 g

Handling precautin:None

Electrical Characteristic

1. Maximum & Thermal Characteristics Ratings at 25°C ambient temperature unless otherwise specified.

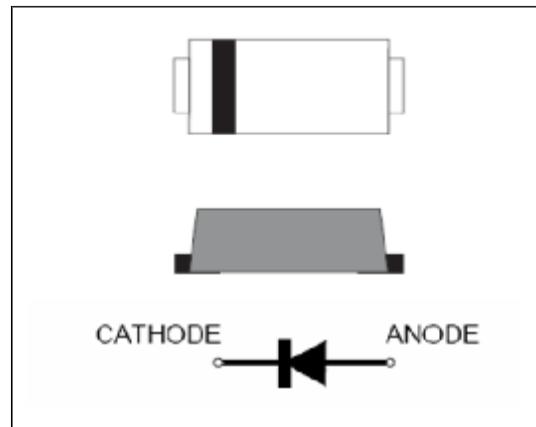
Parameter Symbol	symbol	MEK 4001-D1	MEK 4002-D1	MEK 4003-D1	MEK 4004-D1	MEK 4005-D1	MEK 4006-D1	MEK 4007-D1	Unit
Device marking code		A1	A2	A3	A4	A5	A6	A7	
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current lead length at T _A = 75°C(Note 1)	I _{F(AV)}	1.0						A	
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	30						A	
reverse surger current(20mS)	I _{RSM}	18						mA	
Typical thermal resistance (Note 1)	R _{θJA} R _{θJC}	110 40						°C/W	
Operating junction temperature range	T _J	−55 to +150						°C	
storage temperature range	T _{STG}	−65 to +175						°C	

Electrical Characteristics Ratings at 25°C ambient temperature unless otherwise specified.

Parameter Symbol	symbol	MEK 4001-D1	MEK 4002-D1	MEK 4003-D1	MEK 4004-D1	MEK 4005-D1	MEK 4006-D1	MEK 4007-D1	Unit
Maximum instantaneous forward voltage at 1.0A	V _F	1.1						V	
Maximum DC reverse current at rated DC blocking voltage T _A = 25°C T _j = 100°C	I _R	5.0 50						µA	
Typical junction capacitance at 4.0V, 1MHz	C _J	15.0						PF	

NOTES:

1. 8.0mm² (.013mm thick) land areas



We declare that the material of product is
Halogen free (green epoxy compound)

2.Ratings and Characteristic Curves (TA = 25°C unless otherwise noted)

Fig. 1 - Forward Current Derating Curve

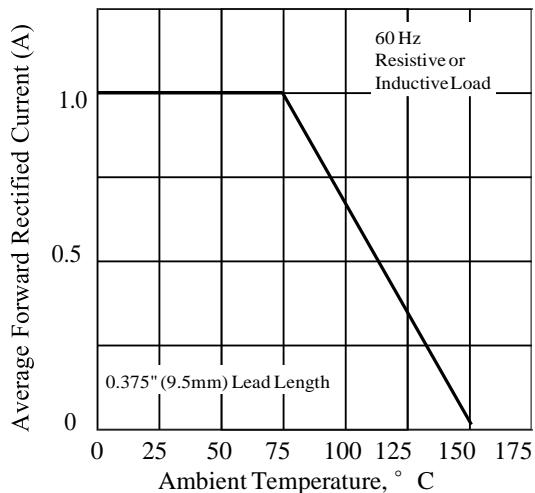


Fig. 3. - Typical Instantaneous Forward Characteristics

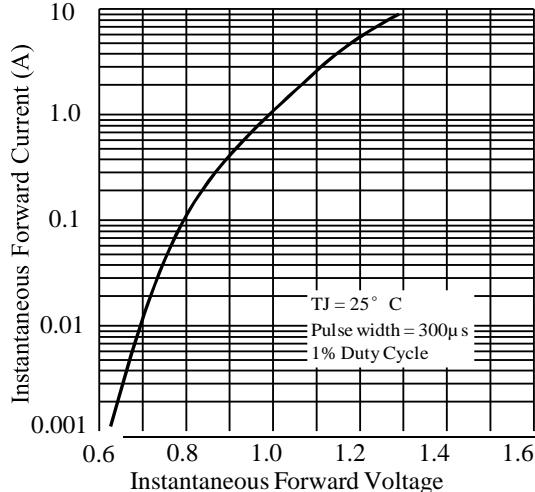


Fig. 5. - typical transient thermal impedance

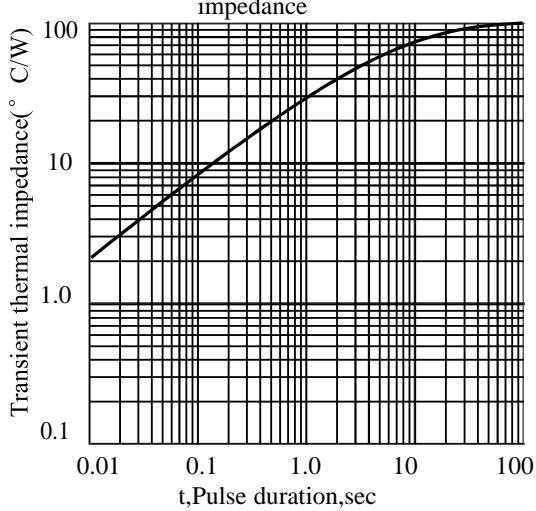


Fig. 2 - Maximum Non-repetitive Peak Forward Surge Current

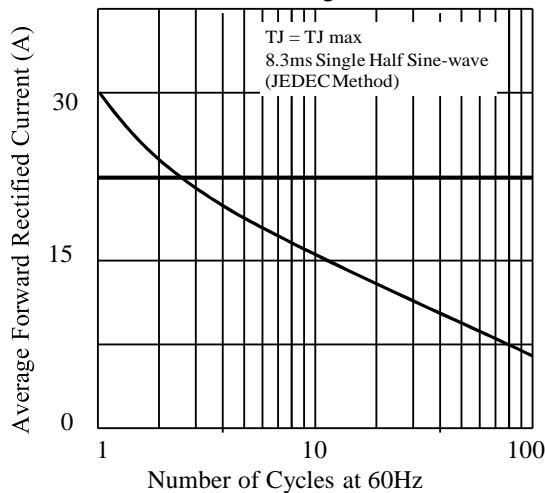


Fig 4. - Typical Reverse Characteristics

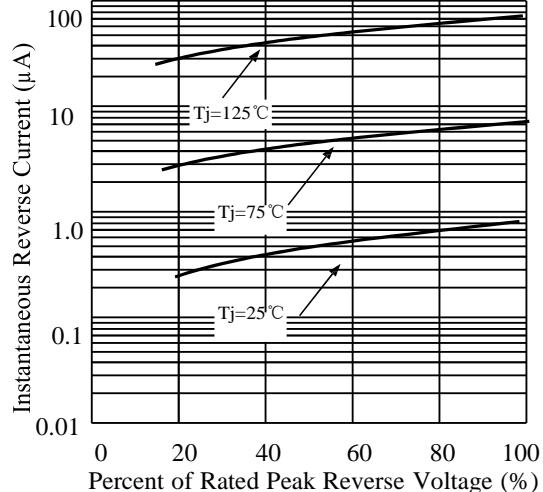
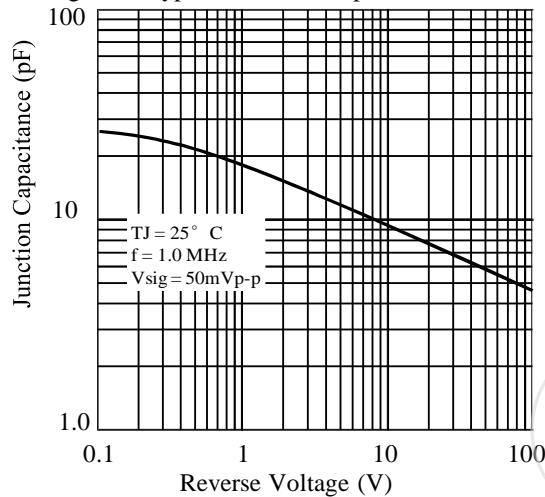
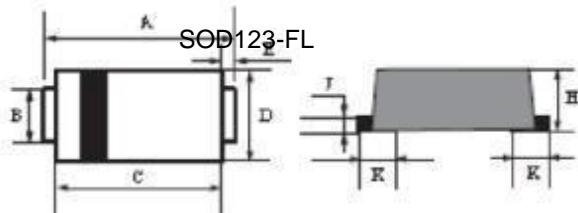


Fig 6. - Typical Junction Capacitance

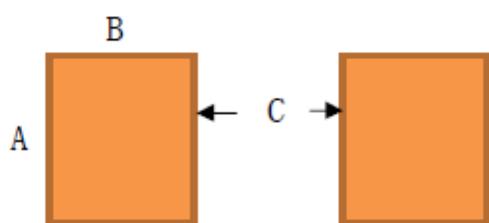


3. dimension:



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	3.5	3.9	0.138	0.159
B	0.75	0.95	0.029	0.037
C	2.6	3.0	0.103	0.119
D	1.6	2.0	0.063	0.079
E	0.45Typ		0.018Typ	
H	0.9	1.2	0.036	0.047
J	0.12	0.22	0.005	0.009
K	0.8Typ		0.032Typ	

Suggested solder pad layout



Dimensions in inches and (millimeters)

PACKAGE	A	B	C
SOD123-FL	0.044(1.10)	0.040(1.00)	0.079(2.00)

